

SparkLAN announces new 802.11ac dual band USB Module

802.11ac/b/g/n USB WiFi module, embedded with MediaTek MT7612U chipset, supports 2x2 (2-stream) MIMO technology and delivers up to 867Mbps.

TAIPEI CITY, TAIWAN, January 9, 2015 /EINPresswire.com/ -- Taipei, Taiwan – Jan 9, 2014 -- SparkLAN introduces its



new wireless 802.11ac/b/g/n Dual-Band (2.4GHz / 5GHz) USB module, embedded with MediaTek latest MT7612U chipset, providing reliable and feature-rich wireless connectivity.

The WUBM-273ACN is USB 3.0 and backwards compatible with USB 2.0. Support advanced 2T2R (2-stream) MIMO technology, it delivers reliable wireless PHY data rate up to 867Mbps to shorten transmission time significantly with higher speed.

It's the ideal choice for USB wireless embedded systems that demand robust link quality and maximum throughput at range.

Key Feature: Chipsets: MediaTek MT7612U Interface: USB Type A or 12-pin wafer connector Antenna: 2 x U.FL connectors or printing antenna Dimension: 55.0mm x 25mm x 3.3mm Speeds up to 867Mbps Advanced security: WEP, WPA, WPA2, 802.1x Support: Windows XP/ Vista/ Win 7/ Win 8, Linux, Android by request Certification: FCC/CE

About SparkLAN Communication, Inc.

SparkLAN Communications, Inc., founded in 2002, is a broadband wireless networking solution provider. Focusing on wireless technology, SparkLAN has had a proven track of taking leading edge technologies developed for four solutions: Embedded System, Wireless ISP, SOHO and Digital Home.

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